PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|---------------------------------|----------------|
| SAMIRAN DASGUPTA | 09/26/2013 |
| DEVRAJ MATHARAMPALLIL RAJAGOPAL | 09/27/2013 |

RECEIVING PARTY DATA

| Name: | Texas Instruments Incorporated |
|-------------------|--------------------------------|
| Street Address: | 12500 TI Boulevard |
| Internal Address: | MS 3999 |
| City: | Dallas |
| State/Country: | TEXAS |
| Postal Code: | 75243 |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 14043535 |

CORRESPONDENCE DATA

Fax Number: (214)479-1273

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 214-479-1246 Email: jscott@ti.com

Correspondent Name: TEXAS INSTRUMENTS INCORPORATED

Address Line 1: 12500 TI BOULEVARD

Address Line 2: MS 3999

Address Line 4: DALLAS, TEXAS 75243

| ATTORNEY DOCKET NUMBER: | TI-73127 |
|-------------------------|------------------|
| NAME OF SUBMITTER: | JONATHON SCOTT |
| Signature: | /Jonathon Scott/ |
| | |

REEL: 031330 FRAME: 0174

PATENT

| Date: | 10/02/2013 |
|--|------------|
| Total Attachments: 2 source=TI-73127_signed_assignment#page source=TI-73127_signed_assignment#page | |

PATENT REEL: 031330 FRAME: 0175

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dailas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s).

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby scknowledged. I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions reissues, substitutions, continuations, and extensions thereof, and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agrees to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful paters, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

| TITLE | A TECHNIQUE TO REALIZE HIGH VOLTAGE IO DRIVER IN A LOW VOLTAGE BICMOS PROCESS |
|---|---|
| NONPROVISIONAL APPLICATION NO. | FILING DATE |
| Name of the state | |
| SIGNATURE OF INVENTOR | a sui vaun . |
| PRINTED NAME OF INVENTOR | Samiran DASGUPTA |
| DATE | 26/03/2013 (00/mm/7777) |
| RESIDENCE (CITY AND STATE) | Bangalore, Karnataka |

PATENT REEL: 031330 FRAME: 0176

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Application No.

| SIGNATURE OF INVENTOR | |
|-------------------------------|---------------------------------|
| PRINTED NAME OF INVENTOR | Devraj Matharampallil RAJAGOPAL |
| DATE | 27/04/2013 |
| RESIDENCE (CITY AND STATE) | Bangalore, Karnataka |

After recording, return Assignment to:

William James Brady Texas Instruments Incorporated PO Box 655474, M/S 3999 Dallas, TX 75265

> PATENT REEL: 031330 FRAME: 0177

RECORDED: 10/02/2013